# HARDNESS AND WEAR RESISTANCE OF ELECTROLESS NICKEL DEPOSITS<sup>®</sup>

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**ABSTRACT** The hardness and wear resistance of electroless nickel deposits with two types of P contents have been investigated. The results indicate that  $N\dot{r}1.5\%$  P deposit possesses as deposited hardness and wear resistance superior to  $N\dot{r}10.5\%$  P deposit. Their hardness and wear resistance can be further improved by proper heat treatment. The optimum wear resistance of  $N\dot{r}1.5\%$  P deposit corresponds to its peak hardness (annealing at 375 °C for 1 h), whereas for  $N\dot{r}10.5\%$  P deposit the optimum wear resistance is obtained after annealing at 650 °C for 1 h.

Key words electroless Nr 1.5% P deposit Nr 10.5% P deposit hardness wear resistance

# 1 INTRODUCTION

Electroless NrP deposits have been widely used in diverse fields for their unique combination of properties such as corrosion resistance, wear resistance, nor magnetism and uniformity of coating thickness<sup>[1-3]</sup>. In the early 1960s, proprietary electroless nickel process suitable for commercial use entered the U.S. market. There existed some limitations in corrosion resistance for these products, which were medium phosphorus deposits (5% ~ 8% P) and commonly used sulfur-containing or heavy-metal stabilizers. In the late 1970s and the 1980s, substantial emphasis was placed on high phosphorus electroless nickel coatings ( $9\% \sim 12\% P$ ). This was due to their amorphous microstructure, improved corrosion resistance, and non-magnetism characteristics [4-6]. The recent development of low phosphorus electroless nickel (1% ~ 5% P) has offered an excellent alternative to hard chromium and nickel-boron coatings due to its superior as deposited hardness and outstanding corrosion resistance in hot alkaline environment, especially suitable for heat sensitive materials such as Al and Al alloys<sup>[7, 8]</sup>. Based on systematic study on the formulation of electroless NèP plating baths, high phosphorus electroless nickel with higher deposition speed and bath stability<sup>[9]</sup> and new low phosphorus electroless nickel deposits<sup>[10]</sup> have been successfully developed (with phosphorus content of 10.5% and 1.5% respectively). In this work, special attention has been focused on the hardness and wear resistance of these two deposits under different heat treatment conditions.

## 2 EXPERIMENTAL PROCEDURE

The hardness of deposits was measured by Micromet II type microhardness tester with a load of 0.5 N for 15 s. The data were obtained for each specimen by averaging five measurements. The wear resistance were determined with a ball and flat machine in dry condition. The flat samples of d50mm made from  $45^{\#}$  steel were plated with 40  $\mu$ m thick NiP coatings. The counterpart was a GCr15 steel ball of d5 mm, with hardness of HRC62. The rotating radius is 15 mm and the rotating speed is 45 r/ min.

The load series are 5, 10, 20, 40 and 80 N, with a testing time of 15 min. The wear rate was expressed by specimen's mass loss after test. The wear tracks were examined in a scanning electron microscope (SEM).

#### 3 RESULTS AND DISCUSSION

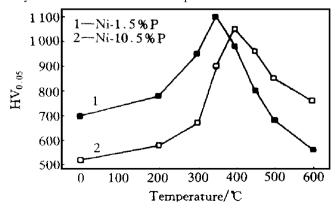
# 3. 1 Hardness of deposits

The microhardness of these two deposits annealed at various temperatures between 200 °C and 600 °C for 1 h is plotted in Fig. 1. The results show that the as-deposited electroless NiP coatings exhibit much higher hardness than that for conventional electrodeposited nickel (250~ 350HV). The TEM and XRD results<sup>[11]</sup> indicated that as deposited Nr 10.5% P deposits were amorphous, while deposits containing 1.5% P could be represented as an fcc NiP supersaturated solid solution of 5~ 10 nm microcrystallites. Nr 1.5% P coating has as deposited hardness of HV700, higher than that of Nir 10.5% P coating (HV520) mainly due to their structural differences. It was shown by DSC<sup>[12]</sup> that crystallization for amorphous Nr 10.5% P deposits occurred at about 300 °C. By XRD it was found that annealing caused the formation of finely dispersed Ni<sub>3</sub>P precipitates, which act as the function of second phases or precipitation hardening because Ni<sub>3</sub>P particles possess higher strength and shearing modulus. The maximum hardness reaches HV 1050 after 400 °C annealing for Nr 10.5% P coating, corresponding to the state of optimum distribution for Ni<sub>3</sub>P particles. Above 400 °C, the hardness of Nr 10.5% P decreases slowly mainly due to the recrystallization of Ni and coarsening of Ni<sub>3</sub>P precipitates. While microcrystalline Ni 1.5% P deposits reach maximum hardness of HV1100 after annealing at lower temperature (350 °C). At higher annealing temperature, the hardness decreases rapidly, even lower than the as-deposited sample (e.g. above 500 °C). It was known from the grain growth behavior of Nr 1.5% P deposits [13], the rapid decrease in hardness has a relation to the grain growth and coarsening of Ni<sub>3</sub>P. Compared with Nr 1. 5% P deposit, Nr 10. 5% P possesses

higher hardness after annealing at a higher temperature and its decrease tendency in hardness after reaching maximum is somewhat gentle due to their difference in fraction of Ni<sub>3</sub>P phases within the coatings. After crystallization, the matrix for Nr 10.5% P deposit is Ni<sub>3</sub>P (about 70% (in volume) Ni<sub>3</sub>P), which acts as the function of volume strengthening, whereas the matrix for Nr 1.5% P is Ni (containing about 10% (in volume) Ni<sub>3</sub>P).

Fig. 2a shows the relationship of hardness vs annealing time at various temperatures for Nr 10.5% P deposits. It can be seen that, the hardness increases gradually with increasing annealing time at a temperature below 400 °C and thereafter keeps at a certain level for longer annealing. The lower the annealing temperature, the longer the time for reaching the peak of hardness. When annealed above 400 °C, the deposits reach a maximum hardness within shorter time and further annealing will cause the slow decrease in hardness. Fig. 2b shows the situation for Nr1.5% P deposit. Nr1.5% P deposits reach peak of hardness after longer annealing time under a temperature below 350 °C, and when the annealing temperature is low (e.g. 300°C), the maximum hardness reached is also lower because Ni<sub>3</sub>P phase precipitate somewhat difficultly. In the case of Nr 1.5% P deposit heat treated at 500 °C, it seems that the maximum hardness actually occurs at a time shorter than the shortest annealing time (10 min).

It can be seen from the above results and analyses that these two deposits with different P



**Fig. 1** Relationship between annealing temperature and hardness of deposits

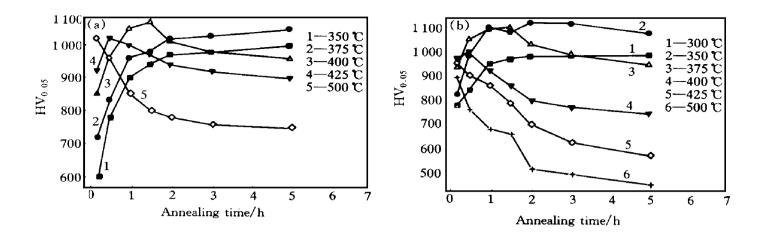


Fig. 2 Relationship between hardness and annealing time at different temperatures
(a) —Nri 10. 5% P; (b) —Nri 1. 5% P

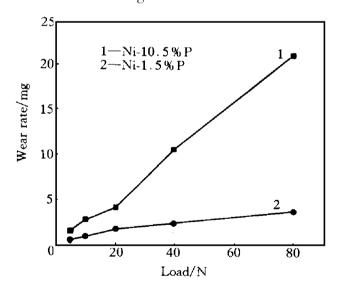
contents show different hardening and softening behaviors during annealing. It seems that the finely dispersed crystallites of Ni<sub>3</sub>P and Ni initially formed progressively aggregate, particularly at higher temperature and longer time. For deposits containing high phosphorus content, this process does little to the reduction of hardness, since the majority of the heat-treated deposit is Ni<sub>3</sub>P. However low phosphorus content deposit shows obvious softening after annealed at a higher temperature for a longer time mainly due to lack and coarsening of Ni<sub>3</sub>P precipitates. Thus, in order to reach maximum hardness, 400 °C, 1h and 375 °C, 1h heat treatments are suitable for Nr 10.5% P and Nr 1.5% P deposits, respectively.

## 3. 2 Wear resistance of deposits

Fig. 3 shows the variation in wear rate with load for as-deposited Nr10.5% P and Nr1.5% P deposits. The wear rate increases with increasing load, and the wear rate for Nr10.5% P is much higher than that for Nr1.5% P. When the load is increased to above 40 N, the wear rate for Nr10.5% P increases rapidly, while that for Nr1.5% P increases only slightly. This indicates that the wear resistance of Nr1.5% P is much better than that of Nr10.5% P deposits at heavy load.

Fig. 4 shows the worn surface morphology of as-deposited Ni 10. 5% P deposits under different loads. Torn patches of coating elongated

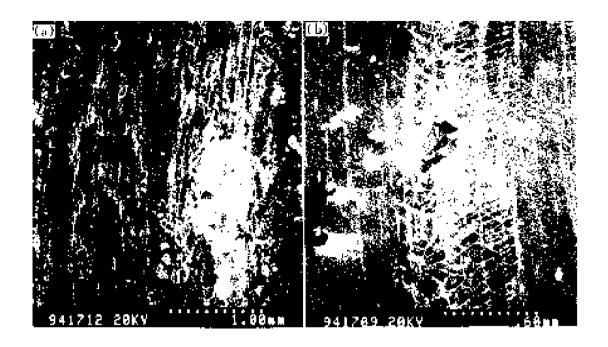
along the wear direction can be seen on worn surface (Fig. 4a), which indicates the phenomena of adhesive wear. Increasing load will cause heavier adhesive wear and obvious plastic deformation within the coating. Further wear causes larger region of the coating to crack and detachment of coating in local areas (position A in Fig. 4b), indicating the worse interface bonding between the coating and the substrate.



**Fig. 3** Relationship between wear rate and load for as deposited electroless nickel deposits

Fig. 5 shows the worn surface of Nr 1.5% P deposits. Within the range of loads tested, adhesive wear has not taken place, which may primarily correspond to their higher hardness and microcrystalline structure.

Fig. 6 shows the relationship between wear



**Fig. 4** Worn surface morphology of as deposited N i 10.5% P deposits under different loads (a) -20 N; (b) -40 N

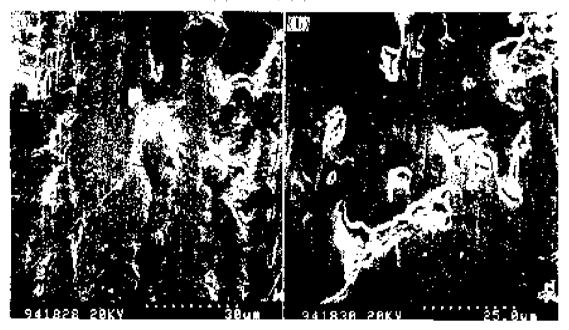
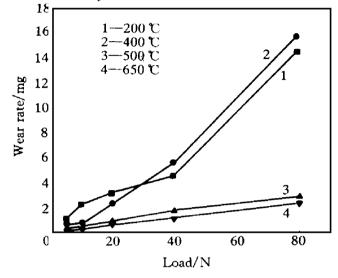


Fig. 5 Worn surface morphology of as deposited N i 1. 5% P deposits under different loads (a) -20 N; (b) -80 N

rate and load for Ni 10.5% P deposits annealed at various temperatures for 1 h. It indicates that the coating annealed at 650 °C for 1 h possesses optimum wear resistance under different load levels. For samples after annealing at 200 °C, severe adhesive wear will take place under a higher load (above 40 N) due to the coating's lower hardness and amorphous structure. After

annealed at 400 °C for 1 h, the coating reaches the peak of hardness, but owing to the increase in brittleness, the coating tends to crack and even detach (Fig. 7a). After heat treatment at 650 °C for 1 h, the coating's hardness decreases somewhat, but the coating's ductility can be improved due to the recrystallization of Ni and coarsening of Ni<sub>3</sub>P, as well as the interface

bonding, which enhances the coating's wear resistance. Fig. 7b shows the worn surface of Nir 10.5% P deposit under 80 N after heat treatment at 650 °C for 1 h. Although there are a number of network cracks on the worn surface, no debris and adhesive phenomena are found.



**Fig. 6** Relationship between wear rate and load for Nir 10. 5% P deposits annealed at different temperatures for 1 h

Fig. 8 shows the wear rate of Ni 1. 5% P deposits annealed at different temperatures. The optimum wear resistance of Ni 1. 5% P deposit

corresponds to heat treatment at 375 °C for 1 h. The higher hardness and the existence of primary phase of ductile Ni within the coating may prevent the coating's cracking during wearing. Annealing at a higher temperature will cause rapid increase in wear rate because of the abrupt decrease in hardness caused by grain growth and agglomeration of Ni<sub>3</sub>P. The lower strength will bring about ploughing phenomena during wearing.

#### 3 CONCLUSIONS

- (1) Ni 1.5% P deposit possesses a much higher as deposited hardness than Ni 10.5% P deposit does. Proper annealing will cause obvious increase in hardness due to the precipitation of Ni<sub>3</sub>P phase within the coating.
- (2) The optimum hardness of Ni 10.5% P deposit corresponds to heat treatment at 400 °C for 1h. The decrease in hardness after annealing at a higher temperature is somewhat gentle for Ni 10.5% P deposit due to the existence of numerous hard phase (Ni 3P), while the optimum hardness of Ni 1.5% P deposit corresponds to heat treatment at 375 °C for 1h. Higher temperature annealing will cause rapid decrease in hard-

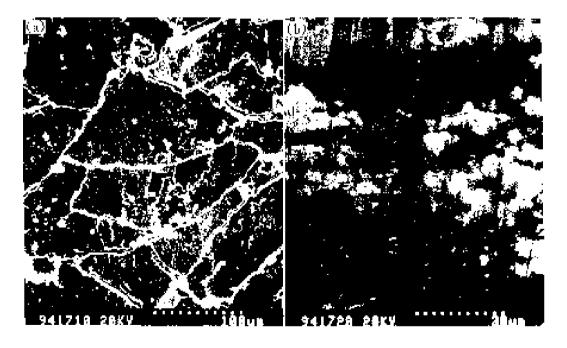
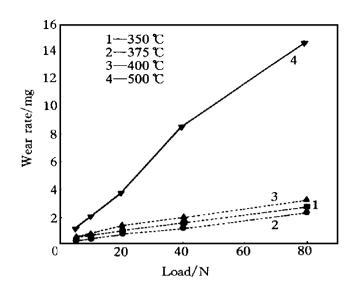


Fig. 7 Worn surface morphology of Ni 10.5% P deposits under 80 N after different heat treatments (a) -400 °C, 1 h; (b) -650 °C, 1 h



**Fig. 8** Relationship between wear rate and load for Nir 1.5% P deposits annealed at different temperatures for 1 h

ness due to the recrystallization of Ni and coarsening of Ni<sub>3</sub>P.

- (3) The wear results of deposits under different loads indicate that, Ni 1.5% P deposit possesses an as deposited wear resistance superior to Ni 10.5% P deposit. The adhesive transfer and ductile tearing are primary mechanisms in the wear of the Ni 10.5% P deposit.
- (4) The wear resistance of deposits can be further improved by proper heat treatment. The wear resistance of Ni 1.5% P deposit varies identically with its microhardness, while for Ni 10.5% P deposit its optimum wear resistance is

obtained after annealing at 650 °C for 1 h. This indicates that not only the coating's hardness but also ductility and adhesion strength will affect the wear resistance for Ni 10.5% P deposit.

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